

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6471796

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BOON YEW LOW	12/22/2020
FERNANDO A. SANTOS	12/23/2020
LI LI	12/22/2020
FUI YEE LIM	12/23/2020
LAN CHU TAN	12/28/2020
RECEIVING PARTY DATA	
Name:	NXP USA, INC.
Street Address:	6501 WILLIAM CANNON DRIVE WEST
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17136408
CORRESPONDENCE DATA	
Fax Number:	(512)895-6630
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4802872998
Email:	lynn.miller@nxp.com
Correspondent Name:	NXP USA, INC. LAW DEPARTMENT
Address Line 1:	6501 WILLIAM CANNON DRIVE WEST TX30/OE62
Address Line 4:	AUSTIN, TEXAS 78735
ATTORNEY DOCKET NUMBER:	82279013US01
NAME OF SUBMITTER:	LYNN MILLER
SIGNATURE:	/Lynn Miller/
DATE SIGNED:	12/29/2020
Total Attachments: 5	
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source=82279013US01_ASSIGN_LIM_signed#page1.tif

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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we, as below-named Assignor/s, hereby sell, assign, and transfer the entire and exclusive right, title, and interest in the following to NXP USA, INC., having a place of business at 6501 West William Cannon Drive, Austin, TX 78735, USA, its successors, assigns, and legal representatives, including any nominees (collectively "the Assignee"):

(1) our invention relating to "CIRCUIT MODULES WITH FRONT-SIDE INTERPOSER TERMINALS AND THROUGH-MODULE THERMAL DISSIPATION STRUCTURES" for which the following patent application(s) has/have been filed (we hereby authorize and request my/our attorneys associated with U.S. Patent & Trademark Office Customer Number 23125 to insert below the filing date and application number of the U.S. application when known):

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US	17/136408	12/29/2020	

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(3) the right to claim priority thereto, and the entire and exclusive right, title, and interest in and to any and all patents granted on these applications.

We authorize and request that the Patent Office officials in the United States and in any and all foreign countries to issue any and all Letters Patent when granted, solely to NXP USA, INC., for its sole use, and that of its successors, assigns, and legal representatives.

We will provide our cooperation to enable the Assignee to enjoy the foregoing right, title, and interest to the fullest extent. Upon request at the expense of the Assignee, we agree to execute all papers, take all rightful oaths, testify in all legal proceedings including patent prosecutorial actions and infringement actions, and do all other such acts which may be necessary, desirable, or convenient for securing and maintaining patents on the foregoing invention or for perfecting title thereto in the Assignee.

We certify that we have the full right to convey the above rights.

22 Dec 2020	<i>Boon Yew Low</i>	Assignor
Date	Boon Yew Low	
Date	Fernando A. Santos	Assignor
Date	Fernando A. Santos	
Date	Li Li	Assignor
Date	Li Li	
Date	Fui Yee Lim	Assignor
Date	Fui Yee Lim	
Date	Lan Chu Tan	Assignor
Date	Lan Chu Tan	

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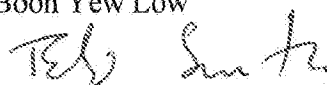
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_____	_____	, Assignor
Date	Boon Yew Low	
DEC-23-2020		, Assignor
_____	Fernando A. Santos	
Date		
_____	_____	, Assignor
Date	Li Li	
_____	_____	, Assignor
Date	Fui Yee Lim	
_____	_____	, Assignor
Date	Lan Chu Tan	

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Date	Boon Yew Low			, Assignor
Date	Fernando A. Santos			, Assignor
<i>Dec. 22, 2020</i>				
Date	Li Li			, Assignor
Date	Fui Yee Lim			, Assignor
Date	Lan Chu Tan			, Assignor

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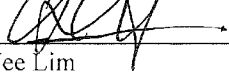
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Date Boon Yew Low

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Date Fernando A. Santos

_____, Assignor
Date Li Li

_____, Assignor
Date 23 DEC 2020 

_____, Assignor
Date Lan Chu Tan

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_____, Assignor
Date 28 DECEMBER '20 Lan Chu Tan